## SONY

# ICX069AKB

### 1/4-inch CCD Image Sensor for PAL Color Video Cameras

#### Description

The ICX069AKB is an interline CCD solid-state image sensor suitable for PAL color video cameras. High resolution is achieved through the use of Ye, Cy, Mg, and G complementary color mosaic filters. At the same time, high sensitivity and low dark current are achieved through the adoption of HAD (Hole-Accumulation Diode) sensors.

This chip features a field period readout system and an electronic shutter with variable charge-storage time.

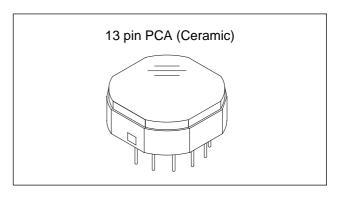
Also, this outline is miniaturized by using original package.

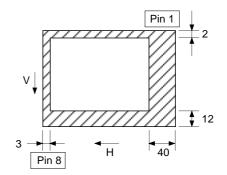
#### Features

- High resolution, high sensitivity and low dark current
- Horizontal register: 3.6 to 5.0V drive
- No voltage adjustment (Reset gate and substrate bias are not adjusted.)
- Low smear
- Excellent antiblooming characteristics
- · Continuous variable-speed shutter
- Ye, Cy, Mg, and G complementary color mosaic filters on chip

#### **Device Structure**

Optical size:	1/4-inch format
Number of effective pixels:	752 (H) $\times$ 582 (V) approx. 440K pixels
<ul> <li>Total number of pixels:</li> </ul>	795 (H) $ imes$ 596 (V) approx. 470K pixels
<ul> <li>Interline CCD image sensor</li> </ul>	
Chip size:	4.47mm (H) × 3.80mm (V)
Unit cell size:	4.85µm (H) × 4.65µm (V)
<ul> <li>Optical black:</li> </ul>	Horizontal (H) direction: Front 3 pixels, rear 40 pixels
	Vertical (V) direction: Front 12 pixels, rear 2 pixels
<ul> <li>Number of dummy bits:</li> </ul>	Horizontal 22
	Vertical 1 (even fields only)
<ul> <li>Substrate material:</li> </ul>	Silicon





Optical black position (Top View)

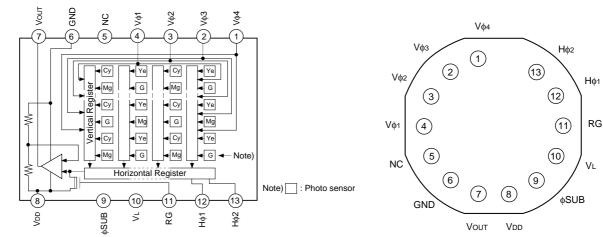
Sony reserves the right to change products and specifications without prior notice. This information does not convey any license by any implication or otherwise under any patents or other right. Application circuits shown, if any, are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits.

RG

VL

#### **Block Diagram and Pin Configuration**

(Top View)



#### **Pin Description**

Pin No.	Symbol	Description	Pin No.	Symbol	Description
1	Vφ4	Vertical register transfer clock	8	Vdd	Supply voltage
2	Vфз	Vertical register transfer clock	9	φSUB	Substrate clock
3	Vφ2	Vertical register transfer clock	10	VL	Protective transistor bias
4	Vφ1	Vertical register transfer clock	11	RG	Reset gate clock
5	NC		12	Ηφ1	Horizontal register transfer clock
6	GND	GND	13	Ηφ2	Horizontal register transfer clock
7	Vout	Signal output			

#### **Absolute Maximum Ratings**

	Item	Ratings	Unit	Remarks
Substrate clock	GND	-0.3 to +40	V	
Currely voltage	Vdd, Vout – GND	-0.3 to +18	V	
Supply voltage	Vdd, Vout – \$SUB	-30 to +9	V	
	Vφ1, Vφ2, Vφ3, Vφ4 – GND	-15 to +16	V	
Clock input voltage	$V\phi_1, V\phi_2, V\phi_3, V\phi_4 - \phi SUB$	to +10	V	
Voltage difference betw	een vertical clock input pins	to +15	V	*1
Voltage difference betw	een horizontal clock input pins	to +16	V	
Ηφ1, Ηφ2 – Vφ4		-16 to +16	V	
Ηφ1, Ηφ2 – GND		-10 to +15	V	
Ηφ1, Ηφ2 – φSUB		-55 to +10	V	
V∟−		-65 to +0.3	V	
Vφ1, Vφ3, Vdd, Vout – V	L	-0.3 to +27.5	V	
RG – GND		-0.3 to +20.5	V	
Vφ2, Vφ4, Hφ1, Hφ2, GNI	D – VL	-0.3 to +17.5	V	
Storage temperature		-30 to +80	°C	
Operating temperature		-10 to +60	°C	

\*1 +24V (Max.) when clock width < 10 $\mu$ s, clock duty factor < 0.1%.

#### **Bias Conditions**

Item	Symbol	Min.	Тур.	Max.	Unit	Remarks
Supply voltage	Vdd	14.55	15.0	15.45	V	
Protective transistor bias	VL		*1	•		
Substrate clock	φSUB		*2			

\*1 VL setting is the VvL voltage of the vertical transfer clock waveform, or the same power supply as the VL power supply for the V driver should be used.

\*2 Do not apply a DC bias to the substrate clock pin, because a DC bias is generated within the CCD.

#### **DC Characteristics**

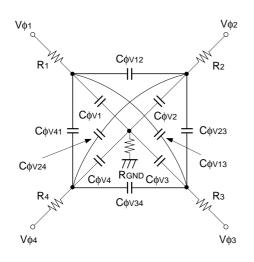
Item	Symbol	Min.	Тур.	Max.	Unit	Remarks
Supply current	Idd		6	8	mA	

#### **Clock Voltage Conditions**

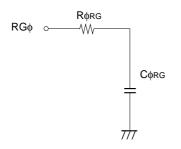
Item	Symbol	Min.	Тур.	Max.	Unit	Waveform diagram	Remarks
Readout clock voltage	Vvт	14.55	15.0	15.45	V	1	
	Vvh1, Vvh2	-0.05	0	0.05	V	2	Vvн = (Vvн1 + Vvн2)/2
	Vvнз, Vvн4	-0.2	0	0.05	V	2	
	Vvl1, Vvl2, Vvl3, Vvl4	-8.0	-7.5	-7.0	V	2	VvL = (VvL3 + VvL4)/2
	Vφv	6.8	7.5	8.05	V	2	$V\phi v = VvHn - VvLn (n = 1 to 4)$
Vertical transfer clock	Vvнз — Vvн	-0.25		0.1	V	2	
voltage	Vvh4 — Vvh	-0.25		0.1	V	2	
	Vvнн			0.3	V	2	High-level coupling
	Vvhl			0.3	V	2	High-level coupling
	Vvlh			0.3	V	2	Low-level coupling
	Vvll			0.3	V	2	Low-level coupling
Horizontal transfer	Vфн	3.3	5.0	5.25	V	3	
clock voltage	Vhl	-0.05	0	0.05	V	3	
	Vørg	4.5	5.0	5.5	V	4	Input through 0.01µF capacitance
Reset gate clock voltage	Vrglh – Vrgll			0.8	V	4	Low-level coupling
	Vrgh	Vdd + 0.3	Vdd + 0.6	Vdd + 0.9	V	4	
Substrate clock voltage	Vфsuв	21.5	22.5	23.5	V	5	

#### **Clock Equivalent Circuit Constant**

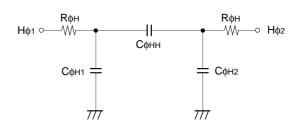
Item	Symbol	Min.	Тур.	Max.	Unit	Remarks
Capacitance between vertical transfer	Cφν1, Cφν3		680		pF	
clock and GND	<b>C</b> φV2, <b>C</b> φV4		470		pF	
	Сфv12, Сфv34		220		pF	
Capacitance between vertical transfer	Сфv23, Сфv41		220		pF	
clocks	СфV13		75		pF	
	СфV24		75		pF	
Capacitance between horizontal transfer clock and GND	Сфн1, Сфн2		33		pF	
Capacitance between horizontal transfer clocks	Сфнн		30		pF	
Capacitance between reset gate clock and GND	Сфр		5		pF	
Capacitance between substrate clock and GND	Сфѕив		170		pF	
Vertical transfer clock series resistor	R1, R2, R3, R4		82		Ω	
Vertical transfer clock ground resistor	Rgnd		15		Ω	
Horizontal transfer clock series resistor	Rфн		39		Ω	
Reset gate clock series resistor	Rørg		39		Ω	



Vertical transfer clock equivalent circuit



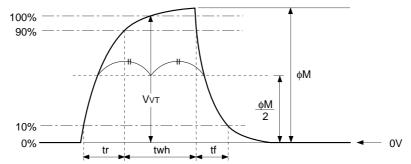
Reset gate clock equivalent circuit



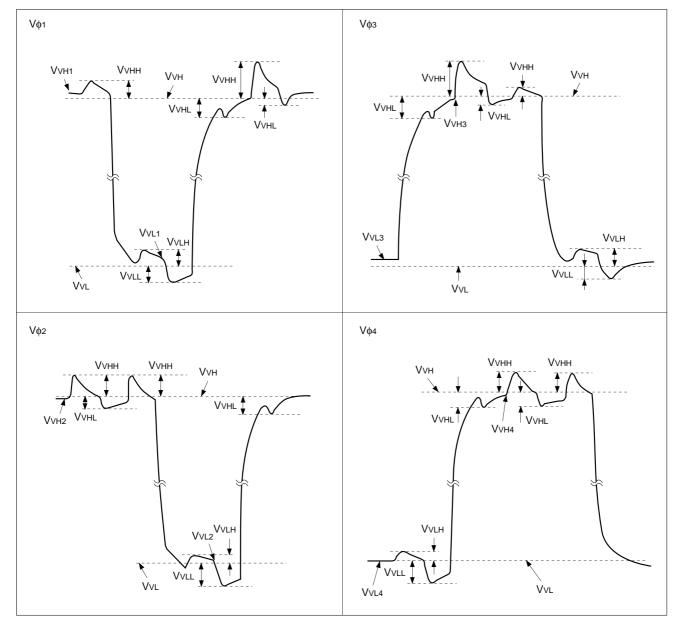
#### Horizontal transfer clock equivalent circuit

#### **Drive Clock Waveform Conditions**

#### (1) Readout clock waveform

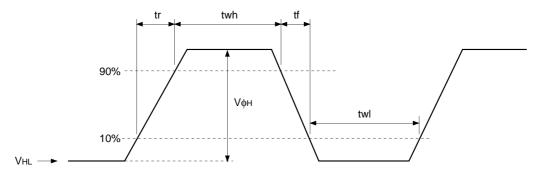




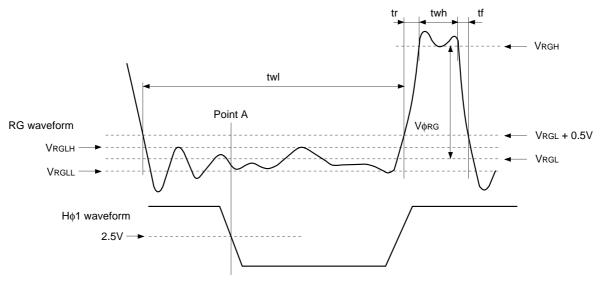


 $V_{VH} = (V_{VH1} + V_{VH2})/2$  $V_{VL} = (V_{VL3} + V_{VL4})/2$  $V_{\varphi V} = V_{VHN} - V_{VLN} (n = 1 \text{ to } 4)$ 

#### (3) Horizontal transfer clock waveform



(4) Reset gate clock waveform



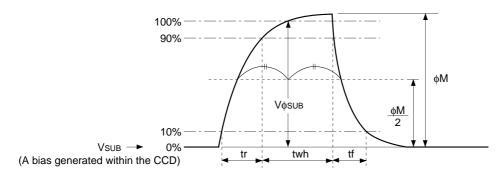
VRGLH is the maximum value and VRGLL is the minimum value of the coupling waveform during the period from Point A in the above diagram until the rising edge of RG. In addition, VRGL is the average value of VRGLH and VRGLL.

VRGL = (VRGLH + VRGLL)/2

Assuming VRGH is the minimum value during the interval twh, then:

 $V\phi RG = VRGH - VRGL$ 

#### (5) Substrate clock waveform



#### **Clock Switching Characteristics**

	Item	Symbol		twh			twl			tr			tf		Linit	Domorko	
	nem	Symbol	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Min. Typ. Max.		Unit	Unit Remarks	
Rea	dout clock	VT	2.3	2.5						0.5			0.5		μs	During readout	
Vert cloc	ical transfer k	Vφ1, Vφ2, Vφ3, Vφ4										15		250	ns	*1	
-×	During	Hφ1	19	24		21	26			10	15		10	15	ns	*2	
onta r clo	imaging	Ηφ2	21	26		19	24			10	15		10	15	115		
Horizontal transfer clock	During parallel-serial	Hφ1		5.38						0.01			0.01				
trai	conversion	Ηφ2					5.38			0.01			0.01		μs		
Res	et gate clock	фRG	11	13			51			3			3		ns		
Sub	strate clock	фѕив	1.5	1.8							0.5			0.5	μs	During drain charge	

\*1 When vertical transfer clock driver CXD1267 is used.

\*2 tf ≥ tr –2ns, and the cross-point voltage (VcR) for the H<sub>φ1</sub> rising side of the H<sub>φ1</sub> and H<sub>φ2</sub> waveforms must be at least V<sub>φH</sub>/2 [V].

Item	Symbol		two	Unit	Remarks	
nem	Symbol	Min.	Тур.	Max.		Remarks
Horizontal transfer clock	Ηφ1, Ηφ2	16	20		ns	*3

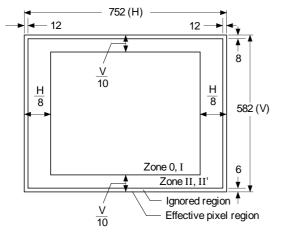
\*3 The overlap period for twh and twl of horizontal transfer clocks H $\phi_1$  and H $\phi_2$  is two.

#### **Image Sensor Characteristics**

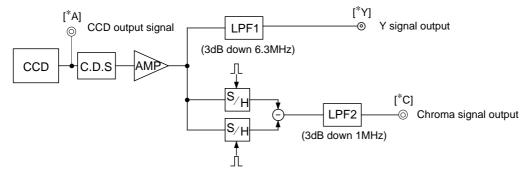
(Ta = 25°C)

Item	Symbol	Min.	Тур.	Max.	Unit	Measurement method	Remarks
Sensitivity	S	220	280		mV	1	
Saturation signal	Ysat	540			mV	2	Ta = 60°C
Smear	Sm		0.009	0.015	%	3	
Video signal shading	SHy			20	%	4	Zone 0 and I
video signal shading	Sily			25	%	4	Zone 0 to II'
Uniformity between video	ΔSr			10	%	5	
signal channels	ΔSb			10	%	5	
Dark signal	Ydt			2	mV	6	Ta = 60°C
Dark signal shading	ΔYdt			1	mV	7	Ta = 60°C
Flicker Y	Fy			2	%	8	
Flicker R-Y	Fcr			5	%	8	
Flicker B-Y	Fcb			5	%	8	
Line crawl R	Lcr			3	%	9	
Line crawl G	Lcg			3	%	9	
Line crawl B	Lcb			3	%	9	
Line crawl W	Lcw			3	%	9	
Lag	Lag			0.5	%	10	

#### Zone Definition of Video Signal Shading



#### **Measurement System**

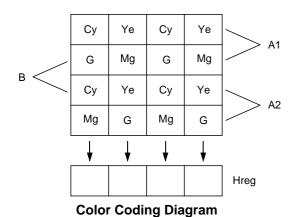


**Note)** Adjust the amplifier gain so that the gain between [\*A] and [\*Y], and between [\*A] and [\*C] equals 1.

#### Image Sensor Characteristics Measurement Method

#### **○** Measurement conditions

- 1) In the following measurements, the device drive conditions are at the typical values of the bias and clock voltage conditions.
- 2) In the following measurements, spot blemishes are excluded and, unless otherwise specified, the optical black level (OB) is used as the reference for the signal output, which is taken as the value of Y signal output or chroma signal output of the measurement system.
- © Color coding of this image sensor & Composition of luminance (Y) and chroma (color difference) signals



As shown in the left figure, fields are read out. The charge is mixed by pairs such as A1 and A2 in the A field. (pairs such as B in the B field)

As a result, the sequence of charges output as signals from the horizontal shift register (Hreg) is, for line A1, (G + Cy), (Mg + Ye), (G + Cy), and (Mg + Ye).

These signals are processed to form the Y signal and chroma (color difference) signal. The Y signal is formed by adding adjacent signals, and the chroma signal is formed by subtracting adjacent signals. In other words, the approximation:

$$Y = \{(G + Cy) + (Mg + Ye)\} \times 1/2$$

is used for the Y signal, and the approximation:

$$R - Y = \{(Mg + Ye) - (G + Cy)\}\$$
  
= {2R - G}

is used for the chroma (color difference) signal. For line A2, the signals output from Hreg in sequence are

$$Mg + Cy$$
), (G + Ye), (Mg + Cy), (G + Ye)

The Y signal is formed from these signals as follows:

 $Y = \{(G + Ye) + (Mg + Cy)\} \times 1/2$ 

This is balanced since it is formed in the same way as for line A1.

In a like manner, the chroma (color difference) signal is approximated as follows:

$$-(B - Y) = \{(G + Ye) - (Mg + Cy)\}\$$
  
=  $-\{2B - G\}$ 

In other words, the chroma signal can be retrieved according to the sequence of lines from R - Y and -(B - Y) in alternation. This is also true for the B field.

#### ◎ Definition of standard imaging conditions

1) Standard imaging condition I:

Use a pattern box (luminance 706cd/m<sup>2</sup>, color temperature of 3200K halogen source) as a subject. (Pattern for evaluation is not applicable.) Use a testing standard lens with CM500S (t = 1.0mm) as an IR cut filter and image at F5.6. The luminous intensity to the sensor receiving surface at this point is defined as the standard sensitivity testing luminous intensity.

2) Standard imaging condition II:

Image a light source (color temperature of 3200K) with a uniformity of brightness within 2% at all angles. Use a testing standard lens with CM500S (t = 1.0mm) as an IR cut filter. The luminous intensity is adjusted to the value indicated in each testing item by the lens diaphragm.

#### 1. Sensitivity

Set to standard imaging condition I. After selecting the electronic shutter mode with a shutter speed of 1/250s, measure the Y signal (Ys) at the center of the screen and substitute the value into the following formula.

$$S = Ys \times \frac{250}{50} [mV]$$

2. Saturation signal

Set to standard imaging condition II. After adjusting the luminous intensity to 10 times the intensity with average value of the Y signal output, 200mV, measure the minimum value of the Y signal.

3. Smear

Set to standard imaging condition II. With the lens diaphragm at F5.6 to F8, adjust the luminous intensity to 500 times the intensity with average value of the Y signal output, 200mV. When the readout clock is stopped and the charge drain is executed by the electronic shutter at the respective H blankings, measure the maximum value YSm [mV] of the Y signal output and substitute the value into the following formula.

 $Sm = \frac{YSm}{200} \times \frac{1}{500} \times \frac{1}{10} \times 100 \text{ [\%] (1/10V method conversion value)}$ 

4. Video signal shading

Set to standard imaging condition II. With the lens diaphragm at F5.6 to F8, adjust the luminous intensity so that the average value of the Y signal output is 200mV. Then measure the maximum (Ymax [mV]) and minimum (Ymin [mV]) values of the Y signal and substitute the values into the following formula.

 $SHy = (Ymax - Ymin)/200 \times 100 [\%]$ 

5. Uniformity between video signal channels

Set to standard imaging condition II. Adjust the luminous intensity so that the average value of the Y signal output is 200mV, and then measure the maximum (Crmax, Cbmax [mV]) and minimum (Crmin, Cbmin [mV]) values of the R – Y and B – Y channels of the chroma signal and substitute the values into the following formula.

 $\Delta Sr = | (Crmax - Crmin)/200 | \times 100 [\%]$  $\Delta Sb = | (Cbmax - Cbmin)/200 | \times 100 [\%]$ 

6. Dark signal

Measure the average value of the Y signal output (Ydt [mV]) with the device ambient temperature 60°C and the device in the light-obstructed state, using the horizontal idle transfer level as a reference.

#### 7. Dark signal shading

After measuring 6, measure the maximum (Ydmax [mV]) and minimum (Ydmin [mV]) values of the Y signal output and substitute the values into the following formula.

 $\Delta$ Ydt = Ydmax – Ydmin [mV]

8. Flicker

1) Fy

Set to standard imaging condition II. Adjust the luminous intensity so that the average value of the Y signal output is 200mV, and then measure the difference in the signal level between fields ( $\Delta$ Yf [mV]). Then substitute the value into the following formula.

 $Fy = (\Delta Yf/200) \times 100 [\%]$ 

2) Fcr, Fcb

Set to standard imaging condition II. Adjust the luminous intensity so that the average value of the Y signal output is 200mV, insert an R or B filter, and then measure both the difference in the signal level between fields of the chroma signal ( $\Delta$ Cr,  $\Delta$ Cb) as well as the average value of the chroma signal output (CAr, CAb). Substitute the values into the following formula.

 $Fci = (\Delta Ci/CAi) \times 100 [\%] (i = r, b)$ 

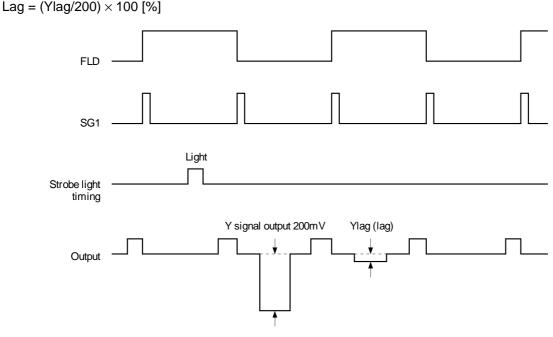
9. Line crawls

Set to standard imaging condition II. Adjust the luminous intensity so that the average value of the Y signal output is 200mV, and then insert a white subject and R, G, and B filters and measure the difference between Y signal lines for the same field ( $\Delta$ Ylw,  $\Delta$ Ylr,  $\Delta$ Ylg,  $\Delta$ Ylb [mV]). Substitute the values into the following formula.

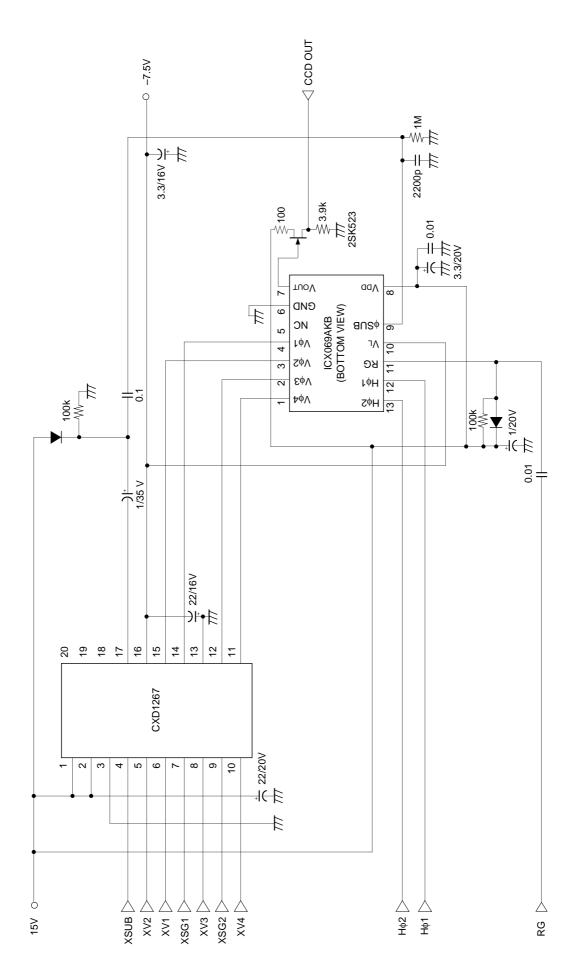
Lci =  $(\Delta Y li/200) \times 100 [\%]$  (i = w, r, g, b)

#### 10. Lag

Adjust the Y signal output value generated by strobe light to 200mV. After setting the strobe light so that it strobes with the following timing, measure the residual signal (Ylag). Substitute the value into the following formula.



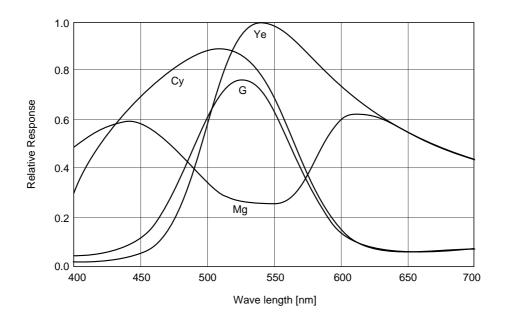
- 11 -



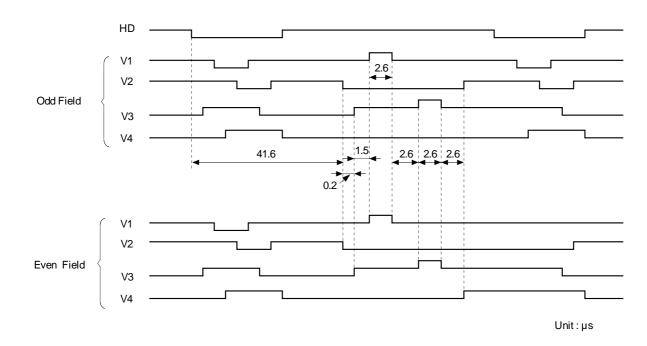
**Drive Circuit** 

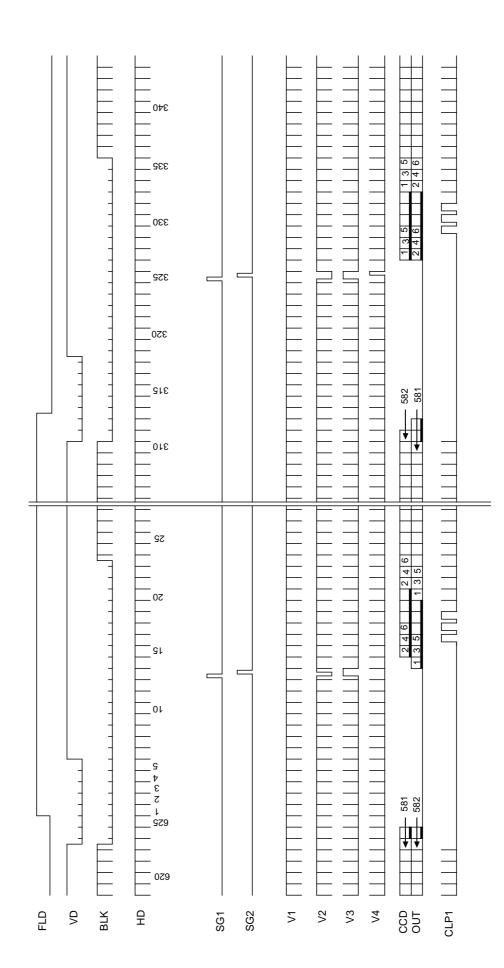
#### **Spectral Sensitivity Characteristics**

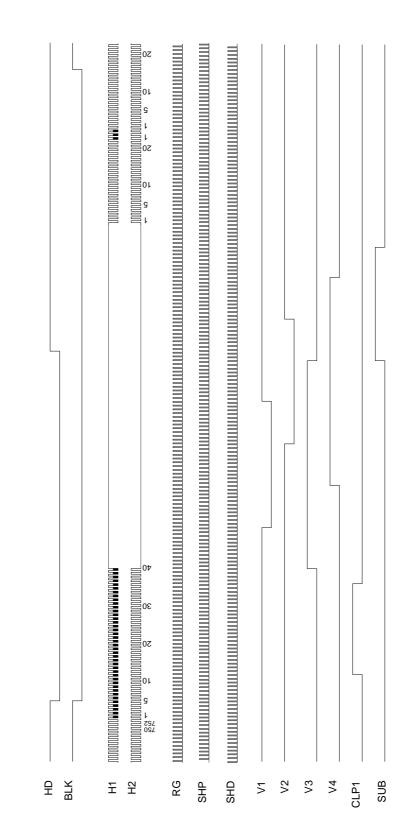
(excludes both lens characteristics and light source characteristics)



#### Sensor Readout Clock Timing Chart







#### **Notes on Handling**

1) Static charge prevention

CCD image sensors are easily damaged by static discharge. Before handling be sure to take the following protective measures.

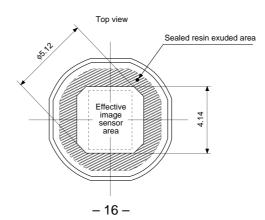
- a) Either handle bare handed or use non-chargeable gloves, clothes or material. Also use conductive shoes.
- b) When handling directly use an earth band.
- c) Install a conductive mat on the floor or working table to prevent the generation of static electricity.
- d) Ionized air is recommended for discharge when handling CCD image sensor.
- e) For the shipment of mounted substrates, use boxes treated for the prevention of static charges.

#### 2) Soldering

- a) Make sure the package temperature does not exceed 80°C.
- b) Solder dipping in a mounting furnace causes damage to the glass and other defects. Use a ground 30W soldering iron and solder each pin in less than 2 seconds. For repairs and remount, cool sufficiently.
- c) To dismount an image sensor, do not use a solder suction equipment. When using an electric desoldering tool, use a thermal controller of the zero cross On/Off type and connect it to ground.
- 3) Dust and dirt protection

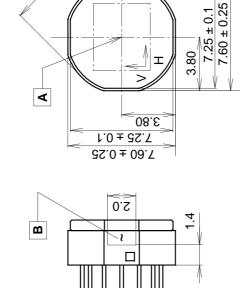
Image sensors are packed and delivered by taking care of protecting its glass plates from harmful dust and dirt. Clean glass plates with the following operation as required, and use them.

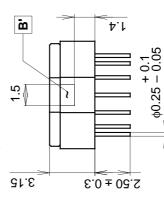
- a) Operate in clean environments (around class 1000 is appropriate).
- b) Do not either touch glass plates by hand or have any object come in contact with glass surfaces. Should dirt stick to a glass surface, blow it off with an air blower. (For dirt stuck through static electricity ionized air is recommended.)
- c) Clean with a cotton bud and ethyl alcohol if the grease stained. Be careful not to scratch the glass.
- d) Keep in a case to protect from dust and dirt. To prevent dew condensation, preheat or precool when moving to a room with great temperature differences.
- e) When a protective tape is applied before shipping, just before use remove the tape applied for electrostatic protection. Do not reuse the tape.
- 4) Do not expose to strong light (sun rays) for long periods, color filters will be discolored. For continuous using under cruel condition exceeding the normal using condition, consult our company.
- 5) Exposure to high temperature or humidity will affect the characteristics. Accordingly avoid storage or usage in such conditions.
- 6) CCD image sensors are precise optical equipment that should not be subject to too much mechanical shocks.
- 7) Eclipse (to get dark around the four corners of the picture) may occur when some object lenses are in the open iris state.





800×0.25







# PACKAGE STRUCTURE

Ceramic	GOLD PLATING	Fe-Ni-Co Alloy	0.4g
PACKAGE MATERIAL	LEAD TREATMENT	LEAD MATERIAL	PACKAGE WEIGHT

#### Φ 0.3 M VL.CO 98.2L ပ 012 G $\odot$ ō. 12-25.71° \@` @@ 0 ଚ OB.BO

- 1. "A" is the center of the effective image area.
- The point "B" of the package is the horizontal reference. The point "B" of the package is the vertical reference. ц Сі
- The bottom "C" of the package is the height reference. *с*і.
- The center of the effective image area relative to the center of the package (\*) is (H, V) = (0, 0)  $\pm$  0.15mm. 4.
- The rotation angle of the effective image area relative to H and V is  $\pm 1^{\circ}$ . <u>ى</u>
- The height from the bottom "C" to the effective image area is  $1.44 \pm 0.15$ mm. <u>ن</u>
- The tilt of the effective image area relative to the bottom "C" is less than 60µm. 7.
- The thickness of the cover glass is 0.75mm, and the refractive index is 1.5. ω.
- \* Center of the package: The center is halfway between two pairs of opposite sides, as measured from "B", "B".